load device, the circuit indicator assembly being configured to emit the circuit status condition detected in the load device, the connector cable, and the electric circuit.

- 30. The device of claim 29, wherein the circuit status indicator assembly further includes at least one standoff member coupled to the printed circuit board and extending in a direction substantially normal to the printed circuit board, the plurality of semiconductor light indicators being coupled to the stand-off member and extending in a direction substantially normal to the at least one standoff member.
- 31. The device of claim 29, wherein the circuit status indicator assembly includes an electromagnetic emission device configured to emit the circuit status condition.
- 32. The device of claim 31, wherein the electromagnetic emission device includes an RF transmission device.
- 33. The device of claim 25, wherein the circuit status condition includes an open hot wire condition.
- 34. The device of claim 25, wherein the circuit status condition includes an open ground status condition.
- 3 5 36. The device of claim 25, wherein the circuit status condition includes a hot and ground reversed status condition.

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See rule 37

- 36 37. The device of claim 25, wherein the circuit status condition includes an open hot wire status condition.
- 37.38. The device of claim 25, wherein the circuit status condition includes a properly wired and grounded status condition.
- 3 \(\frac{3}{3} \). The device of claim 25, wherein the fault detection circuit is configured to detect the circuit status condition in a single phase grounded neutral electrical circuit.
- 34 40. The device of claim 39, wherein the single phase grounded neutral electric circuit supports 120 VAC, 277 VAC, or 347 VAC.
- Host. The device of claim 25, wherein the fault detection circuit is configured to detect the circuit status condition in a multi-phase center grounded electric circuit.